





January 2016



- Pletronics' SM77J Series is a quartz crystal controlled precision square wave generator with a CMOS output.
- The package is designed for high density surface mount designs.
- This is a low cost mass produced oscillator.
- Tape and Reel or cut tape packaging is available.
- 40 to 135 MHz
- 5 x 7 mm LCC Ceramic Package
- Enable/Disable Function
- Disable function includes low standby power mode
- 3rd Overtone Crystals used
- Low Jitter

Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2011/65/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's

Weight of the Device: 0.17 grams

Moisture Sensitivity Level: 1 As defined in J-STD-020C

Second Level Interconnect code: e4

Absolute Maximum Ratings:

Parameter	Unit
V _{CC} Supply Voltage	-0.3V to +4.0V
Vi Input Voltage	-0.3V to V _{CC} + 0.3V
Vo Output Voltage	-0.3V to V _{CC} + 0.3V
lo Output Current	+20 mA to -20 mA

Thermal Characteristics

The maximum die or junction temperature is 125°C

The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.



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Part Number:

SM77	4	5	J	E	X	-125.0M	-XX	
								Packaging code or blank T250 = 250 per Tape and Reel T500 = 500 per Tape and Reel T1K = 1,000 per Tape and Reel
								Frequency in MHz
								Supply Voltage V _{cc} X = 1.8V <u>+</u> 10%
								Optional Enhanced OTR Blank = Temp. range -10 to +70°C C = Temp. range -20 to +70°C E = Temp. range -40 to +85°C
								Series Model
								Frequency Stability 45 = ± 50 ppm 44 = ± 25 ppm 20 = ± 20 ppm
								Series Model

Part Marking and Marking Legend:

PLE SM77 FF.FFF M • YMDxx PLE SM77 FF.FFF M • YYWWxx 7xYWWxx FF.FFF M • PLE xxx

PLE = Pletronics

FF.FFF M = Frequency in MHz

YYWW or YWW or YMD = Date of Manufacture (year and week, or year-month-day)

All other marking is internal factory codes

Specifications such as frequency stability, supply voltage and operating temperature range, etc. are not identified from the marking. External packaging labels and packing list will correctly identify the ordered Pletronics part number.

Codes for Date Code YMD

Code	4	5	6	7	8	Code	A	В	С	D	Е	F	G	Н	J	K	L	M
Year	2014	2015	2016	2017	2018	Mont	h JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
(Code		1	2	3	4	5	6	7	8	9	Α	В	С	D	Е	F	G
	Day		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
(Code		Н	J	K	L	М	N	Р	R	Т	U	٧	W	Х	Υ	Z	
	Day		17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	



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Electrical Specification for 1.80V ±10% over the specified temperature range

Item		Min	Тур	Max	Unit	Condition		
Frequency Ran	ge	40		135	MHz			
Frequency Acc	uracy " 45 "	-50		+50	ppm	For all supply voltages, load changes,		
	"44"	-25		+25		aging for 1 year, shock, vibration and temperatures		
	"20 "	-20		+20				
Output Wavefo	rm		CN	/OS				
Output High Le	vel	V _{cc} -0.4		-	V			
Output Low Lev	⁄el	-		0.4	V			
Output Symmet	ry	45		55	%	at 50% point of V _{CC} (See load circuit)		
Phase Noise	10 Hz		-78		dBc/Hz	at 25 °C, 125 MHz		
	100 Hz		-107		dBc/Hz			
	1 kHz		-132		dBc/Hz			
	10 kHz		-144		dBc/Hz			
	100 kHz		-151		dBc/Hz			
	1 MHz		-155		dBc/Hz			
	10 MHz		-158		dBc/Hz			
Enable/Disable In	iternal Pull-up	30		-	Kohm	to V _{cc}		
V disable		-		30	%	of V _{cc} applied to pad 1		
V enable		70		-	%			
Output leakage	$V_{OUT} = V_{CC}$	-10		+10	uA	Pad 1 low, device disabled		
	$V_{OUT} = 0V$	-10		+10	uA			
Standby Currer	it I _{cc}	-		10	uA			
Disable time		-		200	nS	Time for output to reach a high Z state		
Start up time		-		10	mS	Time for output to reach specified frequency		
Operating Temperature Range		-10		+70	°C	Standard Temperature Range		
		-20		+70	°C	Extended Temperature Range "C"		
		-40		+85	°C	Extended Temperature Range "E"		
Storage Tempe	rature Range	-55		+125	°C			
Output Load Ca	apacitance (CI)	-		15	pF			

A 0.01 nF or larger capacitor mounted proximal to the device between Vcc and Vss is required.



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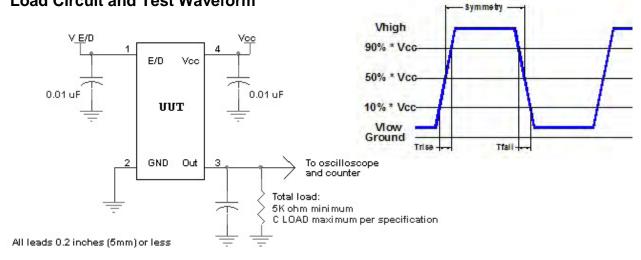
Item	Min	Тур	Max	Unit	Condition	
Output T _{RISE} and T _{FALL}	•	1.5	2.5	nS		C _{LOAD} = 15 pF 10% to 90% of V _{CC} See Load Circuit
V _{cc} Supply Current	-	2.5	5.0	mA	50 MHz	no load
(I _{cc})	-	2.5	5.0	mA	65 MHz	
	-	3.5	7.0	mA	85 MHz	
	-	4.0	7.5	mA	<u>100</u> MHz	
	-	4.5	8.5	mA	133 MHz	

Specifications with Pad 1 E/D open circuit



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Load Circuit and Test Waveform



Reliability: Environmental Compliance

Parameter	Condition
Mechanical Shock	MIL-STD-883 Method 2002, Condition B
Vibration	MIL-STD-883 Method 2007, Condition A
Solderability	MIL-STD-883 Method 2003
Thermal Shock	MIL-STD-883 Method 1011, Condition A

ESD Rating

Model	Minimum Voltage	Conditions		
Human Body Model	1500	MIL-STD-883 Method 3115		
Charged Device Model	1000	JESD 22-C101		

Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Courier New Bar code is 39-Full ASCII

SM7745JEX-125.0M Customer P/N: 12345678

MSL: 1

1000

D/C 0JX-MTG

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

RoHS Compliant

2nd LvL Interconnect

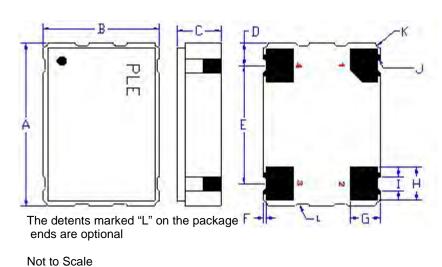
Category=e4

Max Safe Temp=260C for 10s 2X Max



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Mechanical:



	Inches	mm
Α	0.276 <u>+</u> 0.006	7.00 <u>+</u> 0.15
В	0.197 <u>+</u> 0.006	5.00 <u>+</u> 0.15
С	0.068 <u>+</u> 0.018	1.73 <u>+</u> 0.44
D¹	0.038	0.96
E¹	0.200	5.08
F¹	0.004	0.10
G¹	0.050	1.27
H¹	0.055	1.40
l ¹	0.024	0.60
J ¹	0.004	0.10R
K¹	0.008	0.020R

¹ Typical dimensions

Contacts (pads):

Gold 11.8 to 39.4 µinches (0.3 to 1.0 µm) over Nickel 50 to 350 µinches (1.27 to 8.89 µm)

Pad	Function	Note
1	Output Enable/Disable	When this pad is not connected the oscillator shall operate. When this pad is logic low the output will be inhibited (high impedance state.) Recommend connecting this pad to $V_{\rm cc}$ if the oscillator is to be always on.
2	Ground (GND)	
3	Output	
4	Supply Voltage (V _{cc})	Recommend connecting appropriate power supply bypass capacitors as close as possible.

Layout and application information

For Optimum Jitter Performance, Pletronics recommends:

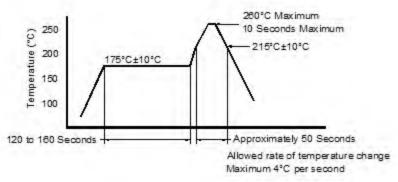
- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.





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Reflow Cycle (typical for lead free processing)



The part may be reflowed 3 times without degradation.

Tape and Reel: available for quantities of 250 to 1000 per reel (< 250 = cut tape)

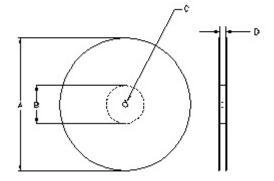
	Constant Dimensions Table 1									
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max		
8mm		1.0			2.0					
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05					
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1		
24mm		1.5			<u>+</u> 0.1					

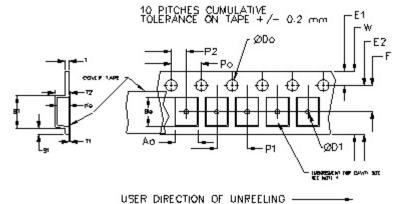
	Variable Dimensions Table 2									
Tape B1 E2 Min F P1 T2 W Ao, Bo & Ko Size Max Max Ko										
16 mm 12.1 14.25 7.5 ±0.1 8.0 ±0.1 8.0 16.3 Note 1										

Note 1: Embossed cavity to conform to EIA-481-B

Dimensions in mm

Not to scale





		REE	L DIMENSI	ONS	
Α	inches	7.0	10.0	13.0	
	mm	177.8	254.0	330.2	
В	inches	2.50	4.00	3.75	
	mm	63.5	101.6	95.3	Tape Width
С	mm	13	wiatri		
D	mm	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.4 +2.0 -0.0	16.0

Reel dimensions may vary from the above